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## MBRP30045CT

## POWERTAP || Switch-mode Power Rectifier

These state-of-the-art devices use the Schottky Barrier principle with a platinum barrier metal.

## Features

- Dual Diode Construction - May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage
- $150^{\circ} \mathrm{C}$ Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Pb -Free Package is Available*


## Mechanical Characteristics:

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25-40 lb-in max
- Base Plate Torques:

See procedure given in the Package Outline Section

MAXIMUM RATINGS

| Rating | Symbol | Max | Unit |
| :---: | :---: | :---: | :---: |
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | $V_{\text {RRM }}$ $\mathrm{V}_{\mathrm{RWM}}$ $V_{R}$ |  | $0$ |
| Average Rectified Forward Current (Rated $\mathrm{V}_{\mathrm{R}}, \mathrm{T}_{\mathrm{C}}=140^{\circ} \mathrm{C}$ ) <br> Per Leg Per Device | $\mathrm{I}_{\mathrm{F}(\mathrm{AV})}$ | $\begin{aligned} & 150 \\ & 300 \end{aligned}$ |  |
| Peak Repetitive Forward Current, (Rated $\mathrm{V}_{\mathrm{R}}$, Square Wave, <br> $20 \mathrm{kHz}, \mathrm{T}_{\mathrm{C}}=140^{\circ} \mathrm{C}$ ) <br> Per Leg | IFRM | $300$ | A |
| Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz ) Per Leg |  | 2500 | A |
| Peak Repetitive Reverse Current ( $2.0 \mu \mathrm{~s}, 1.0 \mathrm{kHz}$ ) | IRRM | 2.0 | A |
| Storage Temperature Range | $\mathrm{T}_{\text {stg }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Operating Junction Temperature | $\mathrm{T}_{J}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Voltage Rate of Change (Rated $\mathrm{V}_{\mathrm{R}}$ ) | dv/dt | 10,000 | V/us |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

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## SCHOTTKY BARRIER RECTIFIER 300 AMPERES, 45 VOLTS



| B30045T | $=$ Specific Device Code |
| :--- | :--- |
| MCC | = Mold Compound Code |
| A | $=$ Assembly Location |
| YY | Year |
| WW | $=$ Work Week |
| G | Pb-Free Package |

ORDERING INFORMATION

| Device | Package | Shipping |
| :--- | :---: | :---: |
| MBRP30045CT | POWERTAP II | 25 Units/Tray |
| MBRP30045CTG | POWERTAP II <br> (Pb-Free) | 25 Units/Tray |

THERMAL CHARACTERISTICS (Per Leg)

| Rating | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Thermal Resistance, Junction-to-Case | $\mathrm{R}_{\text {өJc }}$ | 0.45 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

ELECTRICAL CHARACTERISTICS (Per Leg)

| Instantaneous Forward Voltage (Note 1) <br> $\left(\mathrm{i}_{\mathrm{F}}=150\right.$ Amps, $\left.\mathrm{T}_{J}=25^{\circ} \mathrm{C}\right)$ <br> $\left(\mathrm{i}_{F}=300\right.$ Amps, $\left.\mathrm{T}_{J}=25^{\circ} \mathrm{C}\right)$ | $\mathrm{v}_{\mathrm{F}}$ | V |
| :--- | :---: | :---: |
| Instantaneous Reverse Current (Note 1) <br> (Rated dc Voltage, $\left.\mathrm{T}_{J}=125^{\circ} \mathrm{C}\right)$ | 0.70 |  |
| (Rated dc Voltage, $\left.\mathrm{T}_{J}=25^{\circ} \mathrm{C}\right)$ | $\mathrm{i}_{\mathrm{R}}$ |  |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width $=300 \mu \mathrm{~s}$, Duty Cycle $\leq 2.0 \%$.

## MAXIMUM MECHANICAL RATINGS

| Terminal Penetration: | 0.235 max |
| :--- | :--- |
| Terminal Torque: | $25-40$ in- lb max |
| Mounting Torque - <br> Outside Holes: | $30-40$ in-lb max |
| Mounting Torque - <br> Center Hole: | $8-10$ in-lb max |
| Seating Plane <br> Flatness | 1 mil per in. <br> (between mounting holes) |

Note: While the POWERTAP is capable of sustaining these vertical and levered tensions, the intimate contact between POWERTAP and heat sink may be lost. This could lead to thermal runaway. The use of very flexible leads is recommended for the anode connections. Use of thermal grease is highly recommended.

## MBRP30045CT

## MOUNTING PROCEDURE

The POWERTAP package requires special mounting considerations because of the long longitudinal axis of the copper heat sink. It is important to follow the proper tightening sequence to avoid warping the heat sink, which can reduce thermal contact between the POWERTAP and heat sink.

## STEP 1:

Locate the POWERTAP on the heat sink and start mounting bolts into the threads by hand (2 or 3 turns).


## STEP 2:

Finger tighten the center bolt. The bolt may catch on the threads of the heat sink so it is important to make sure the face of the bolt or washer is in contact with the surface of the POWERTAP.

## STEP 3:

Tighten each of the end bolts between 5 to 10 in-lb.


## STEP 4:

Tighten the center bolt between 8 to $10 \mathrm{in}-\mathrm{lb}$.


STEP 5:
Finally, tighten the end bolts between 30 to 40 in-lb.


## MBRP30045CT

## PACKAGE DIMENSIONS

CASE 357C-03
POWERTAP
PLASTIC PACKAGE
ISSUE E


NOTES

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH
3. TERMINAL PENETRATION: 5.97 (0.235) MAXIMUM.

|  | INCHES |  |  | MILLIMETERS |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DIM | IIN |  | MAX | MIN |  |
| A | 3.450 | 3.635 | 87.63 | 92.33 |  |
| B | 0.700 | 0.810 | 17.78 | 20.57 |  |
| C | 0.615 | 0.640 | 15.63 | 16.26 |  |
| E | 0.120 | 0.130 | 3.05 | 3.30 |  |
| F | 0.435 | 0.445 | 11.05 | 11.30 |  |
| G | 1.370 | 1.380 | 34.80 | 35.05 |  |
| H | 0.007 | 0.030 | 0.18 | 0.76 |  |
| N | $1 / 4-20 U N C-2 B$ | $1 / 4-20 U N C-2 B$ |  |  |  |
| Q | 0.270 | 0.285 | 6.86 | 7.23 |  |
| R | 31.50 | BSC | 80.01 |  |  |
| BSC |  |  |  |  |  |
| U | 0.600 | 0.630 | 15.24 | 16.00 |  |
| V | 0.330 | 0.375 | 8.39 | 9.52 |  |
| W | 0.170 | 0.190 | 4.32 | 4.82 |  |

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[^1]:    *For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

